

Characterization of nanomaterials and nanostructures in the SEM using On-Axis TKD technique

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Stress



Strain

EBSD/TKD

Outline



01 Spatial resolution: On-Axis TKD vs. EBSD vs. Conventional TKD

02 Augmented On-Axis TKD in SEM – capabilities and benefits

03 *Invited speaker: Dr. Alice Bastos da Silva Fanta*

04 Q&A Session

Spatial resolution

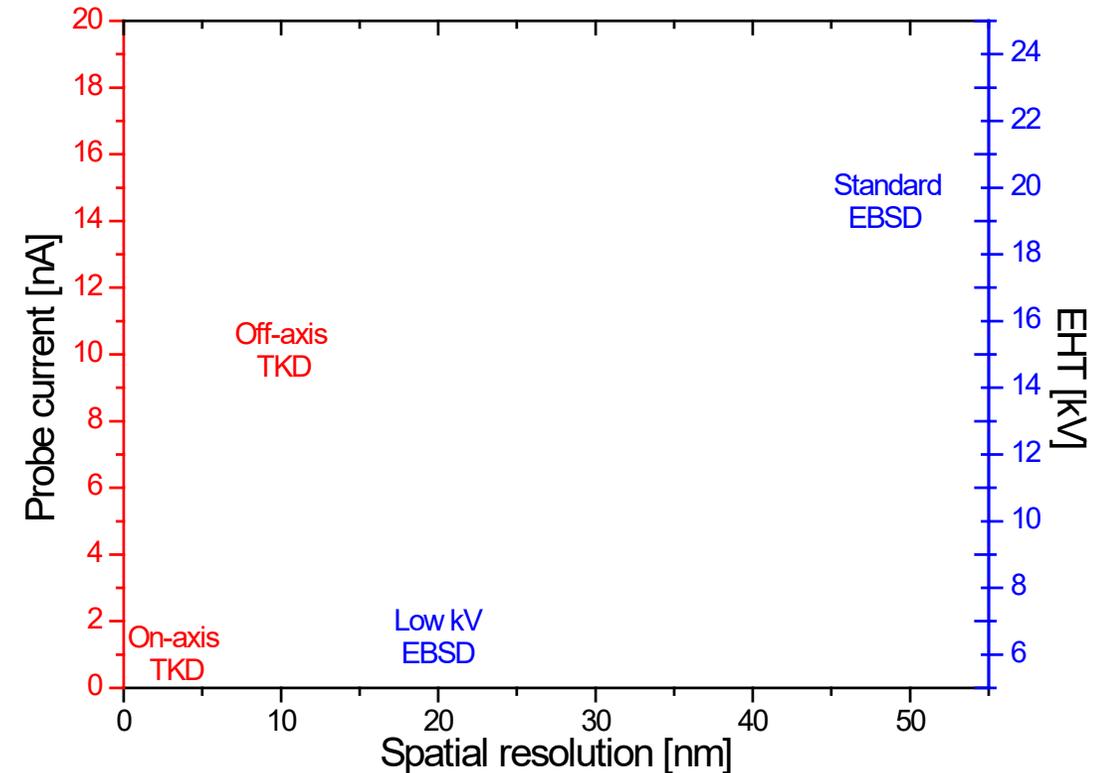
EBSD vs. conventional TKD vs. On-Axis TKD



- Physical Spatial Resolution (PSR) is set by the interaction volume
- Effective Spatial Resolution (ESR) is given by the SW ability to correctly index patterns produced by multiple crystals

Effective spatial resolution values:

- EBSD at 20kV: down to ~50nm
- Low-kV EBSD: down to ~20nm
- Conventional TKD, a.k.a. t-EBSD: down to ~8nm
- On-Axis TKD: down to ~2nm

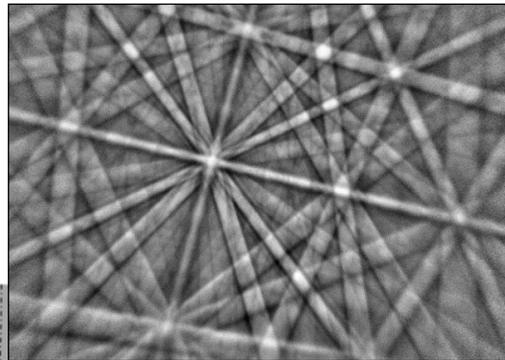


Experimental setup

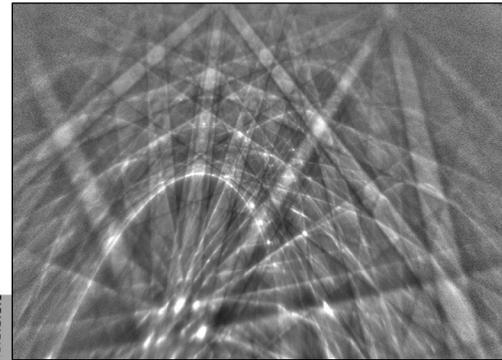
EBSD vs. conventional TKD vs. On-Axis TKD



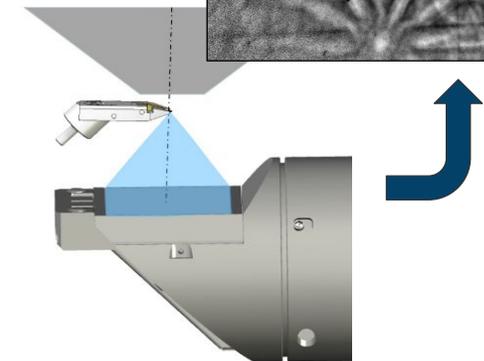
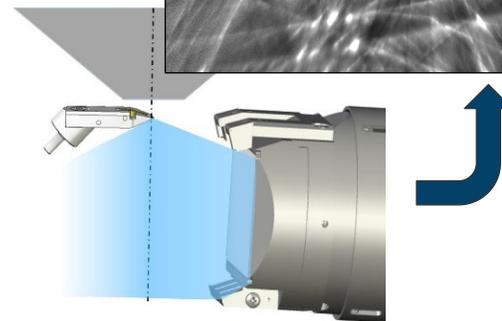
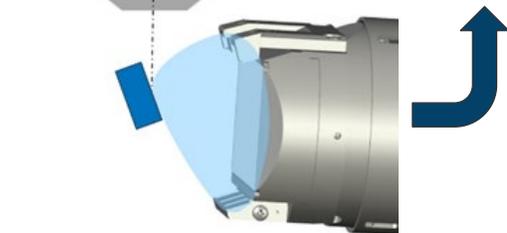
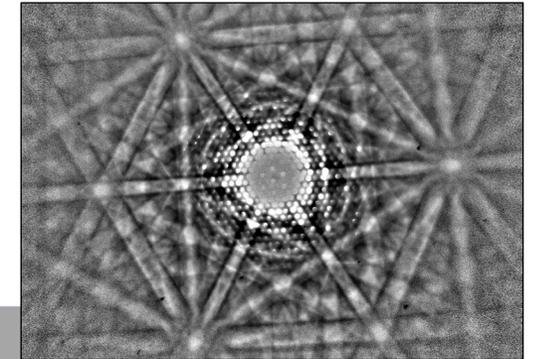
Standard EBSD



Conventional (Off-Axis) TKD



On-Axis TKD



- EBSD and standard TKD use the same hardware & software
- Non-optimum sample-detector geometry for TKD ⇔ **weak signal**

- Additional hardware – OPTIMUS 2
- Provides optimum sample-detector geometry for TKD ⇔ **strong signal**

„Orientation mapping by transmission-SEM with an on-axis detector” J.J. Funderberger et al, Ultramicroscopy, 161, 17–22, 2016.

“A systematic comparison of on-axis and off-axis transmission Kikuchi diffraction” F. Niessen et al, Ultramicroscopy, 186, 158-170, 2018.

On-Axis TKD

“More signal, more better!” 😊...but why?

We all want to acquire orientation maps with:

1. Best spatial resolution to resolve even the finest crystals/features
2. Fastest speed possible to use lab's resources efficiently
3. Highest indexing rate, i.e. reliable data to help us get a realistic understanding of sample's properties

All the above is possible but it “costs” signal:

1. Signal to allow lowering the probe current (probe diameter) without damaging the pattern quality
2. Signal to compensate for the lower exposure times required by high speed pattern acquisition
3. Signal to produce low noise / high quality patterns enabling high indexing rates

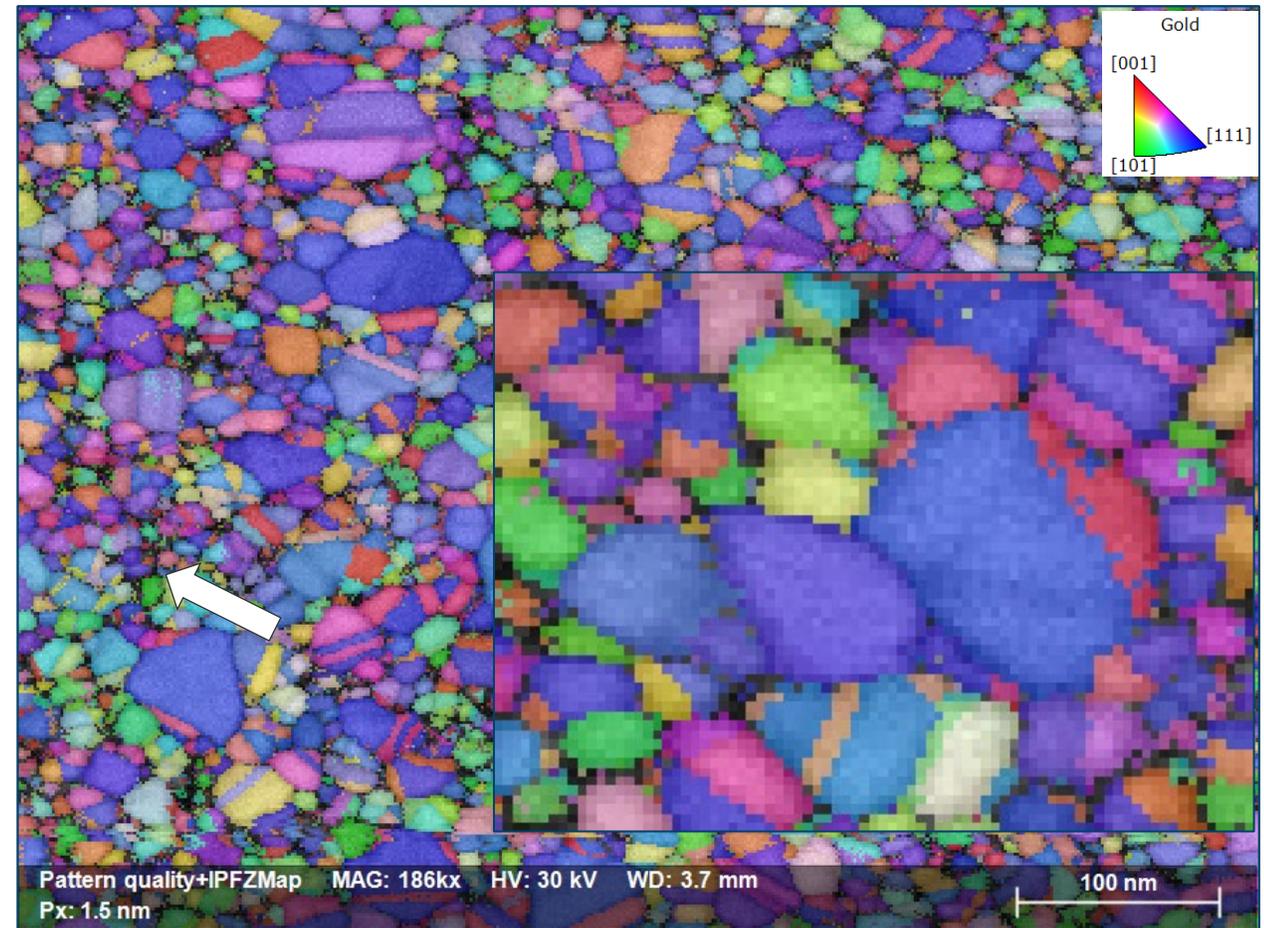
On-Axis TKD

Best spatial resolution, speed and data quality



- Important parameters:
- EHT: 30kV
- Probe current: 2nA
- Step size: 1.5nm
- Mapping speed: 320fps (3ms/point)
- Total acquisition time: 6:31min
- Zero solutions: 11.5%
- Annealing twin: ~4nm wide
- No data cleaning!

20nm Au film on 5nm Si₃N₄ membrane

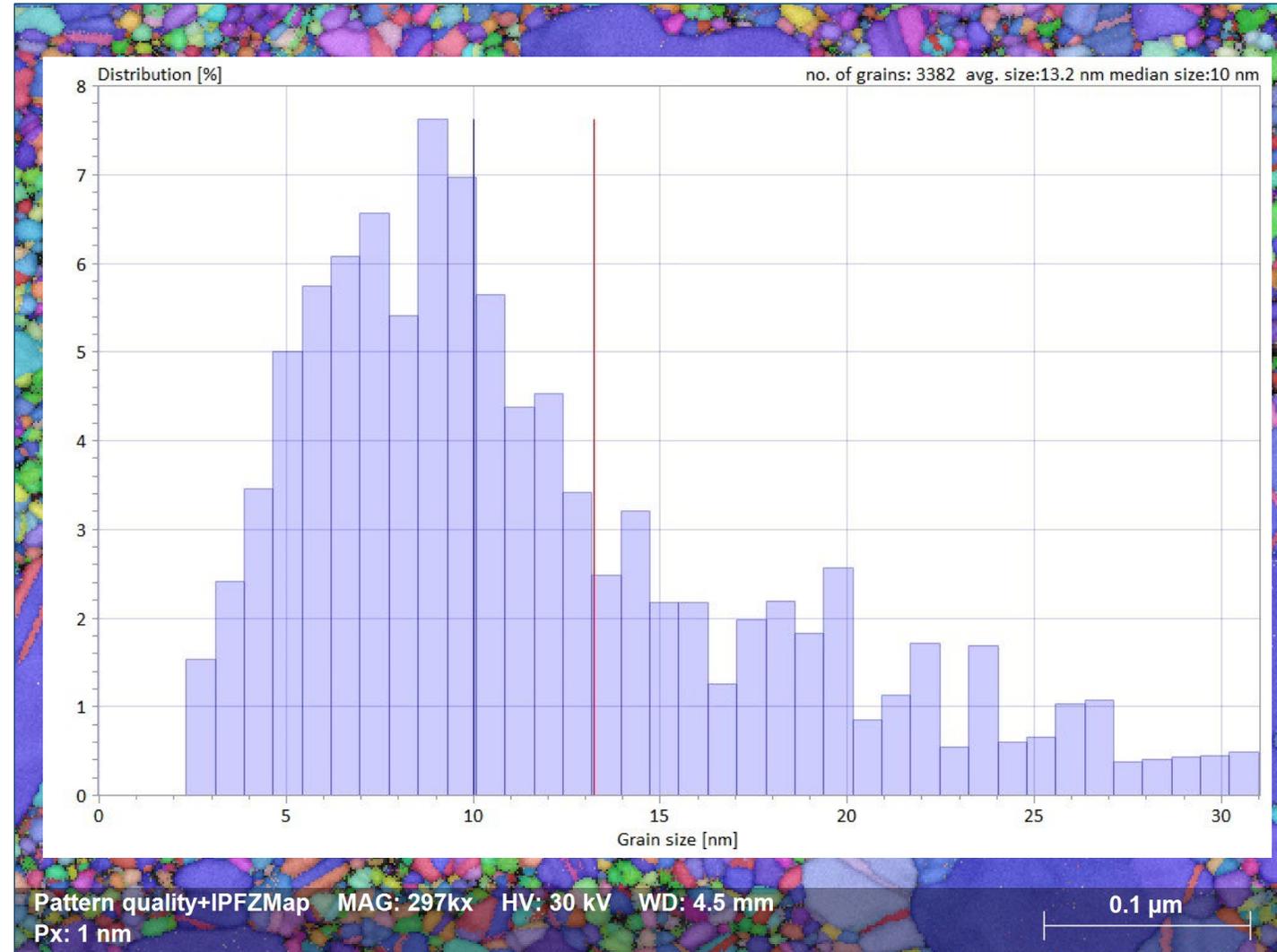


On-Axis TKD

Reliable data & great statistics

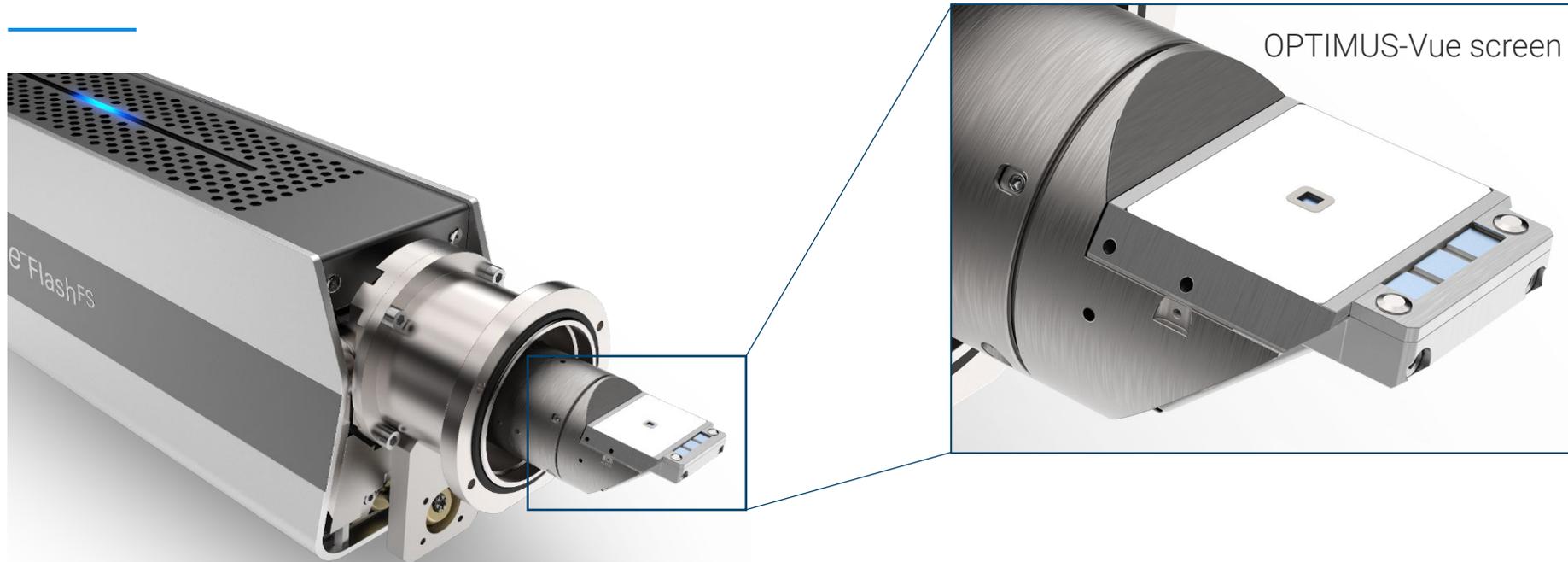


- Important parameters:
- EHT: 30kV
- Probe current: 1.5 nA
- Step size: 1nm
- Mapping speed: 243fps (4 ms/point)
- Total acquisition time: 19:15 min
- Zero solutions: 5.73 %
- No data cleaning!
- 3382 grains smaller than 33 nm with a mean equivalent diameter size of 13.2 nm



OPTIMUS 2 detector head for On-Axis TKD

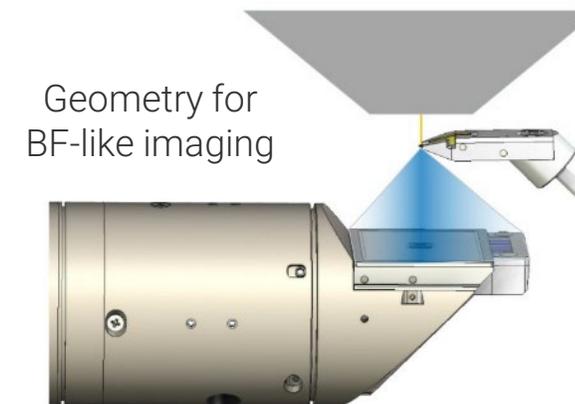
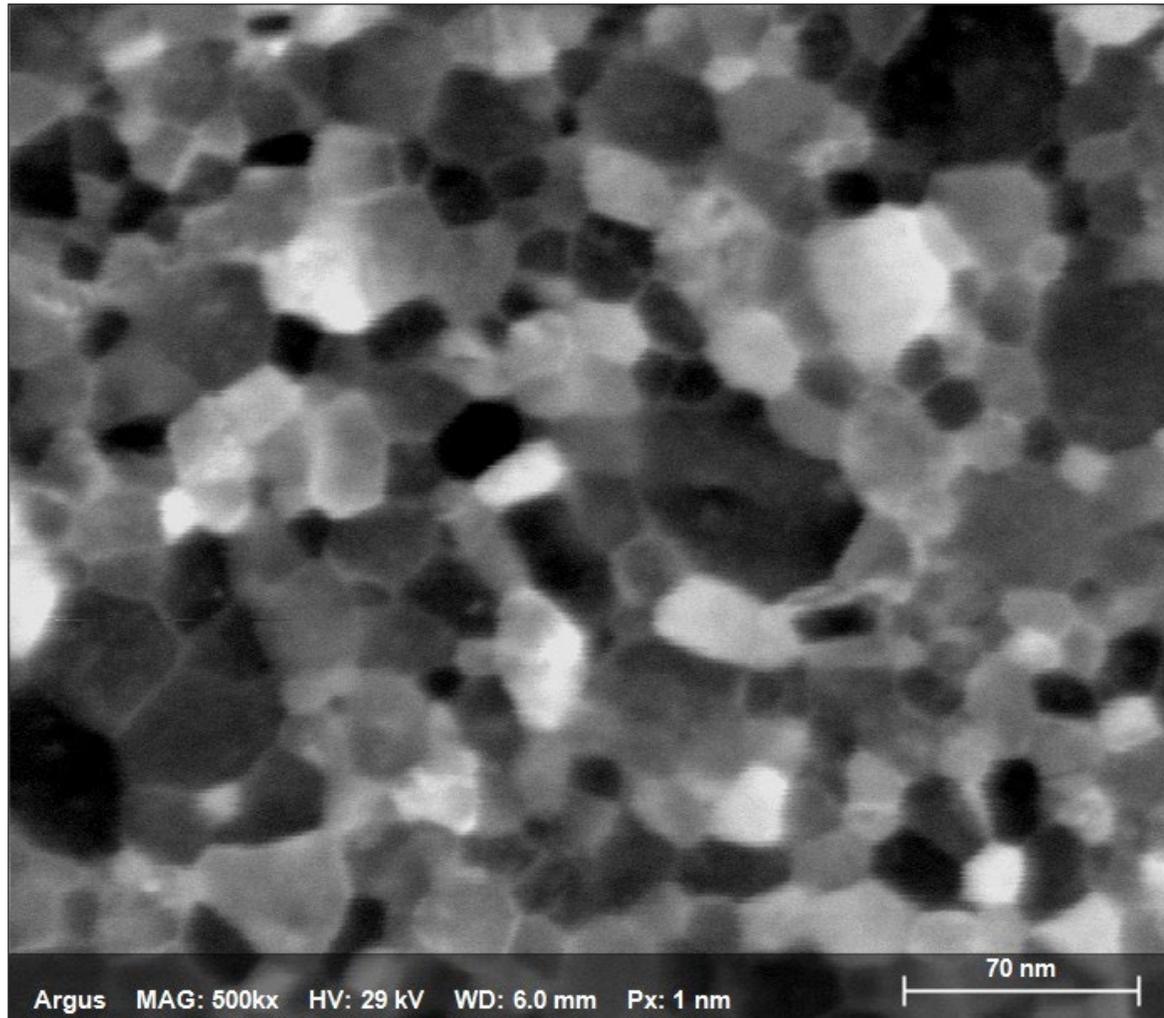
Features & benefits



- OPTIMUS-Vue screen – BF-like imaging in mapping position (more details later)
- e- beam friendly materials – *improved spatial resolution and minimized drift*
- Additional layer in screen structure – *minimized beam interference*
- Redesigned screen frame – *easier/safer to use*

High resolution BF imaging with OPTIMUS 2

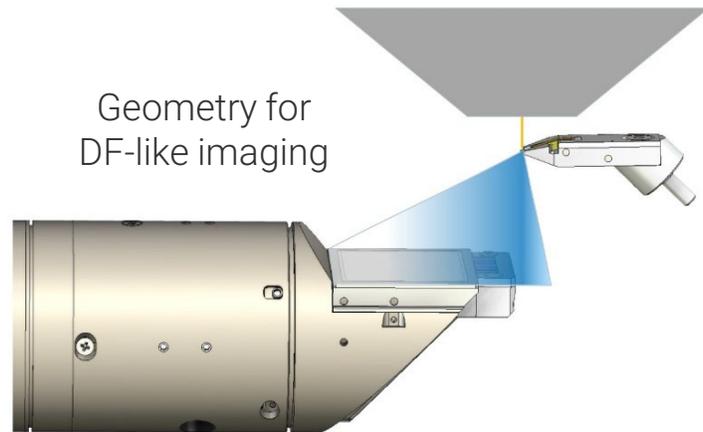
20 nm Ru film deposited on 5 nm TiN & Si wafer



- BF image acquired with OPTIMUS on a high-end SEM equipped with immersion lens technology
- Pixel size: 0.5 nm
- Accelerating voltage: 29 kV
- Probe current: 0.4 nA
- Acquisition time: 3 seconds

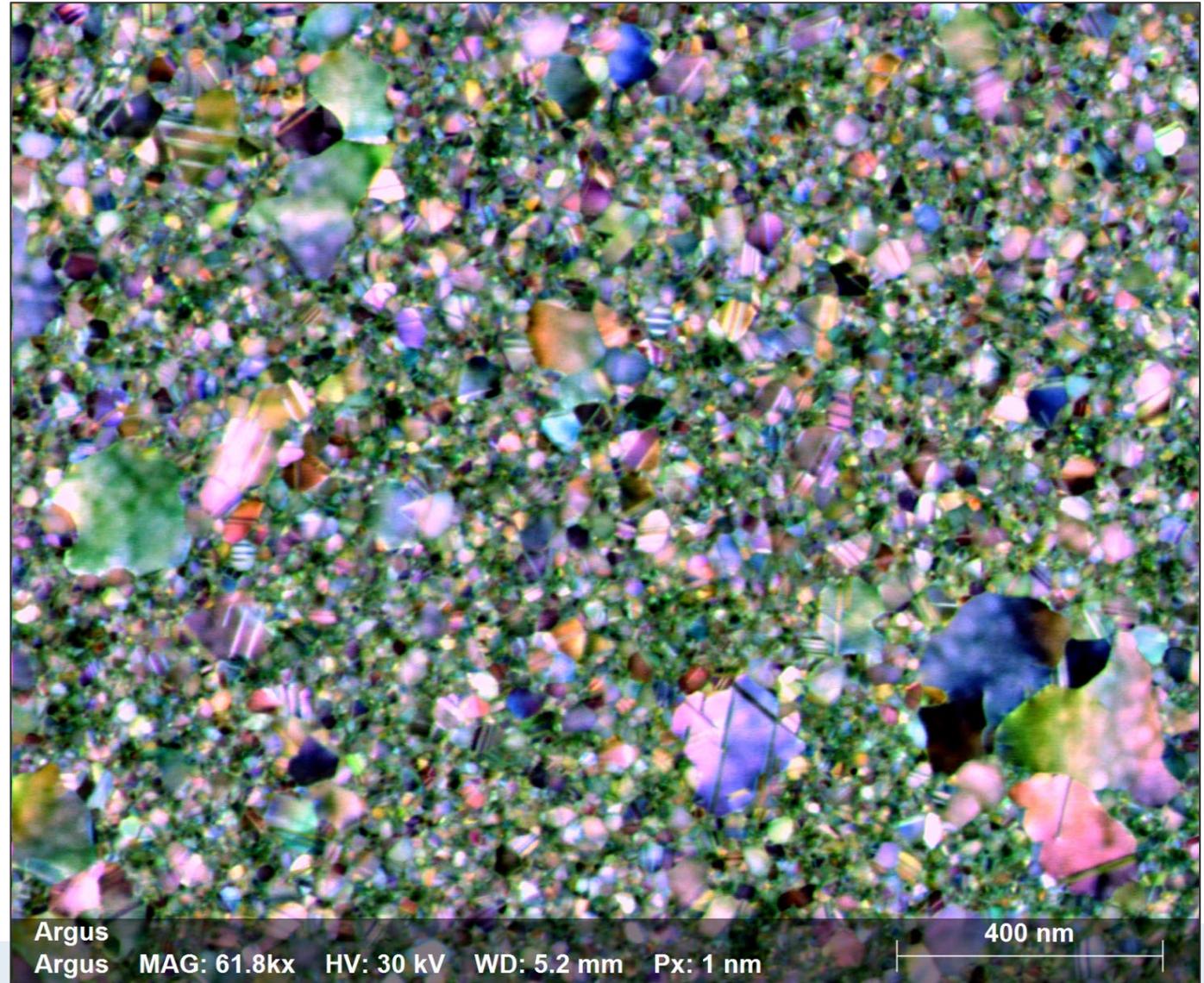
High resolution DF imaging with OPTIMUS 2

15 nm Au film deposited on 10 nm Si₃N₄ membrane



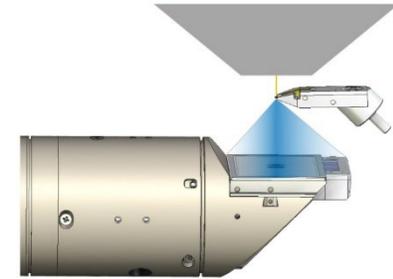
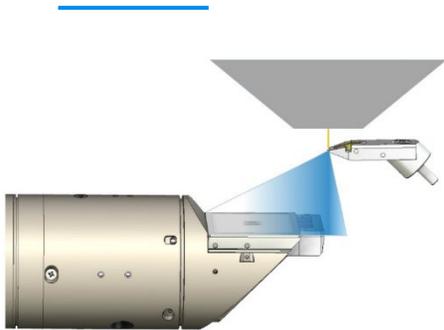
High resolution DF image acquired at 30kV with 0.8nA probe current and a pixel size of 1 nm

Image is courtesy of Hong Zhang from Eurofins in Santa Clara CA, USA



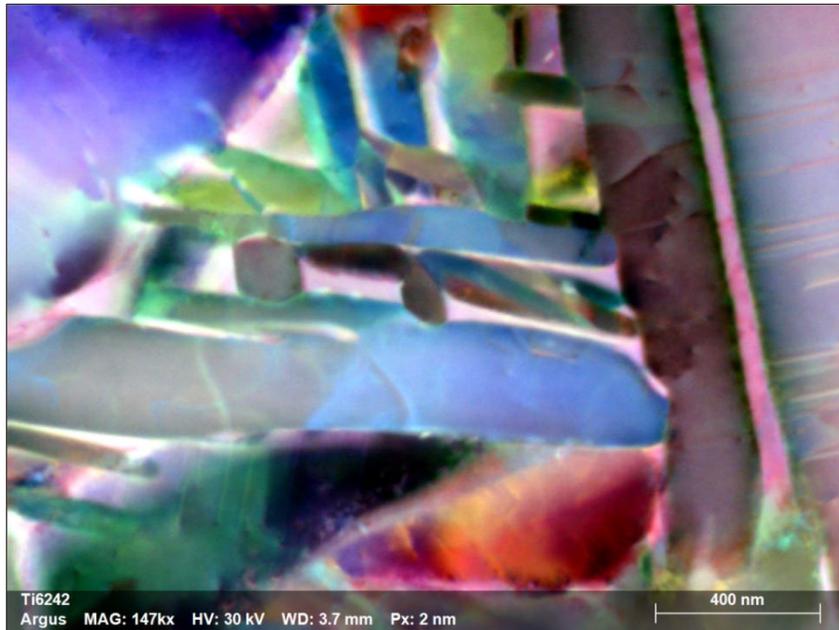
DF & BF imaging with OPTIMUS 2

Ti 6242 alloy



Applications & benefits:

- Qualitative characterization of microstructures
- Finding area/features of interest
- Refining beam focus and astigmatism
- Ideal for drift correction
- Essential for three new SW features:
 - ESPRIT FIL-TKD
 - ESPRIT TRM
 - ESPRIT MaxYield



Ti 6242 alloy

Sample is courtesy of Ben Britton from The University of British Columbia, Canada (formerly with Imperial College London)



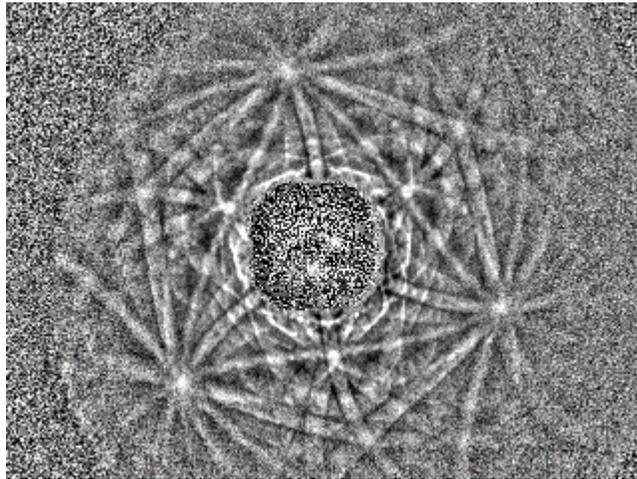
Ti 6242 alloy

ESPRIT FIL-TKD

Enabling nano-scale TKD mapping



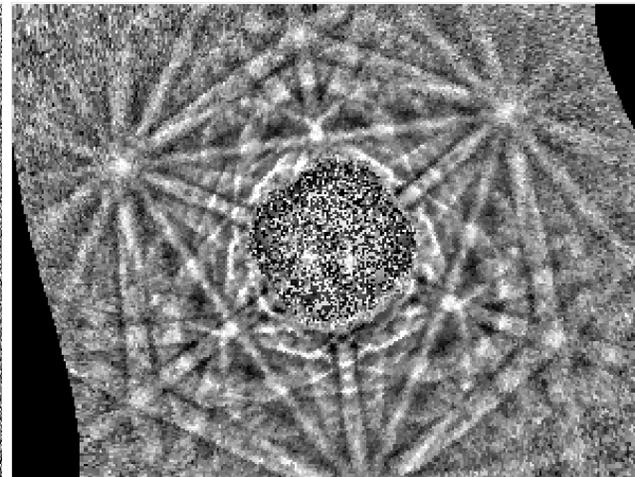
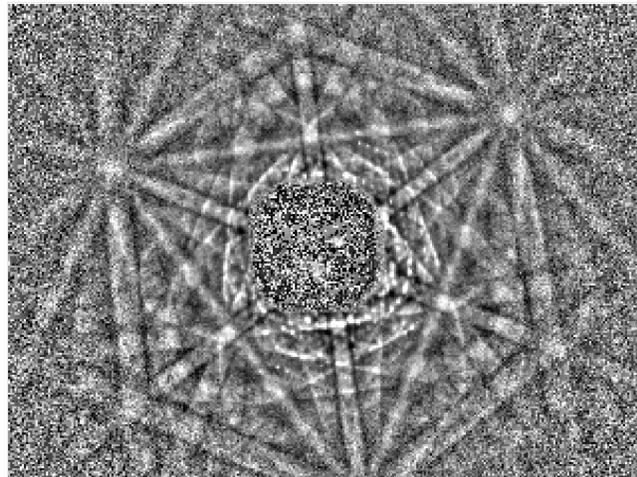
With field



FIL-TKD



No field



- Immersion mode \Leftrightarrow Strong Magnetic Field inside SEM chamber
 - Electrons are constrained within a narrow space around the optical axis of SEM – *limits their spread laterally*
 - Electron trajectories are affected – *distorted patterns*
- OPTIMUS 2 and ESPRIT FIL-TKD help overcome these limitations

Goal: Achieve the best spatial resolution possible!

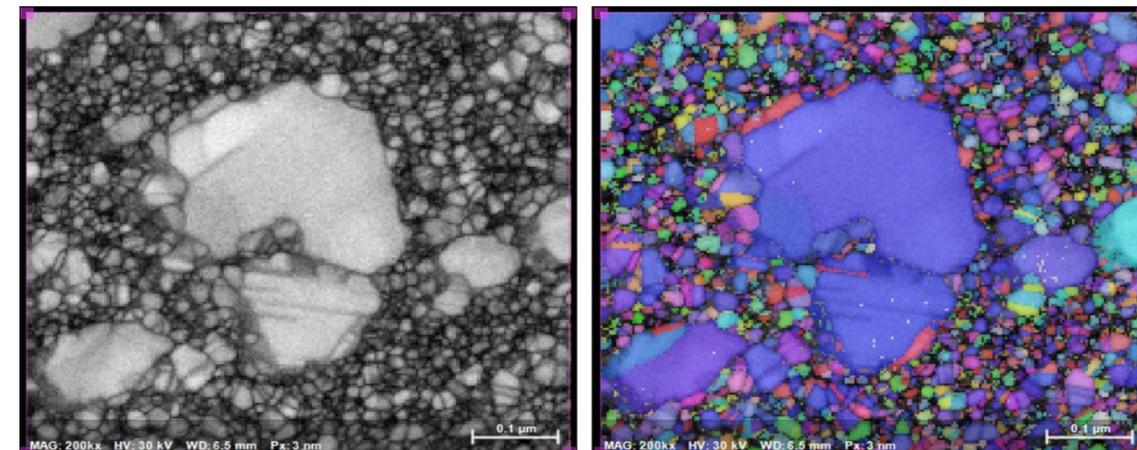
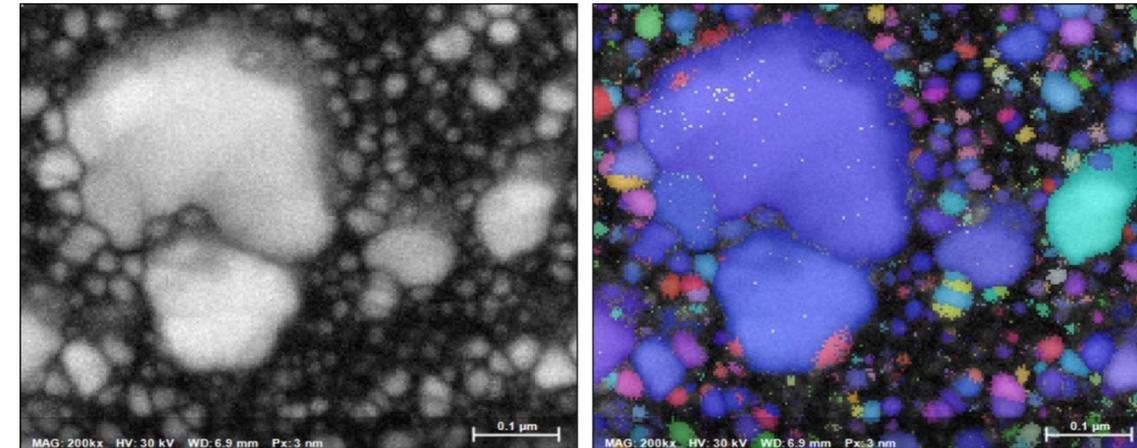
ESPRIT FIL-TKD

Enabling nano-scale TKD mapping



- Available for certain SEMs using **F**ull **I**mmersion **L**ens technology
- Fully integrated in the pattern analysis process of ESPRIT 2
- Works for all applications except residual strain analysis
- Results show here were acquired using a +10 years old NovaNano SEM
- **DISCLAIMER:** Resolution difference between the two functioning modes is very likely not as dramatic on latest gen. e- columns

No magnetic field ⇔ analytical mode

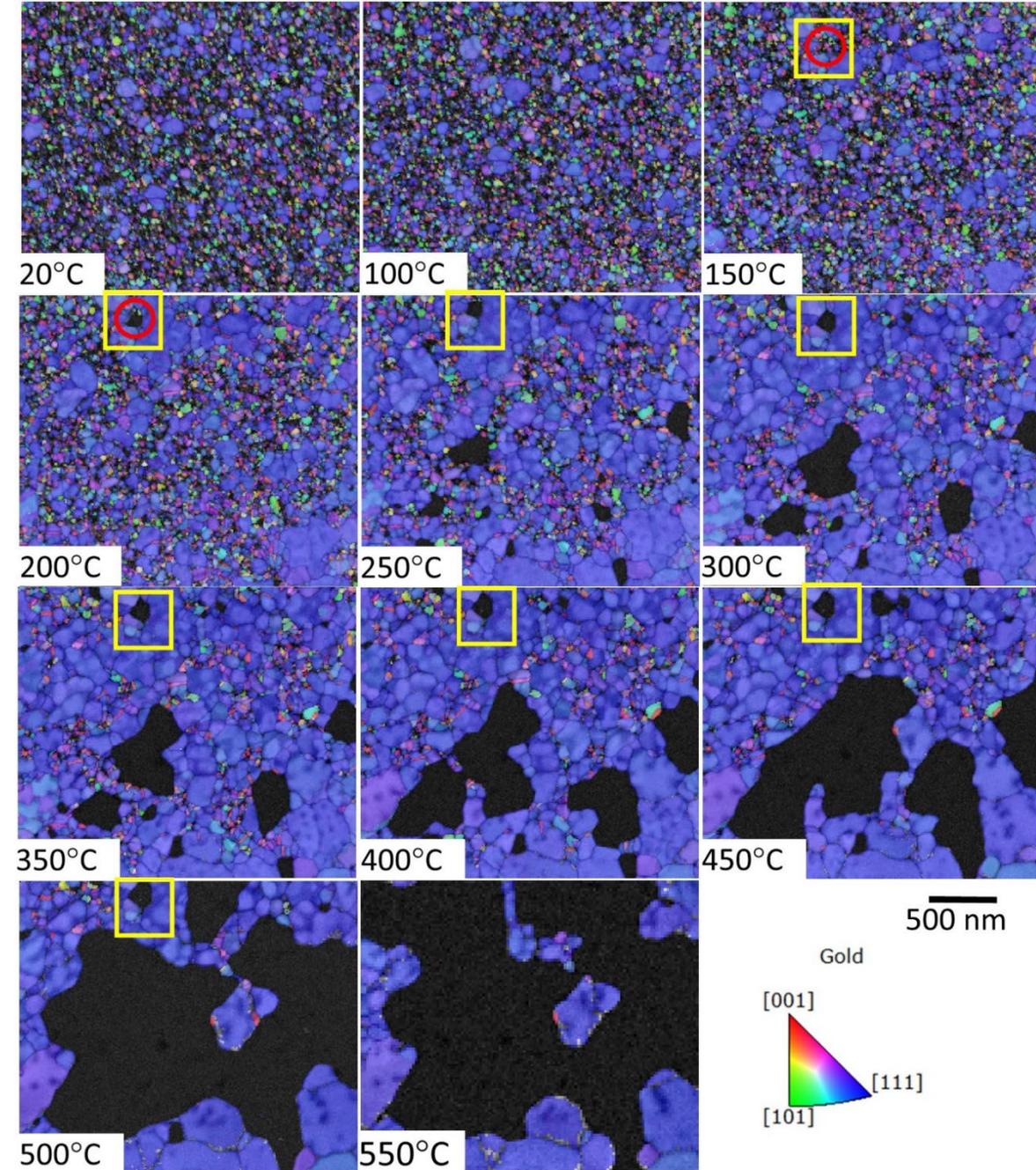


With magnetic field ⇔ Ultra-High Resolution (UHR) mode

ESPRIT TRM

Time Resolved Measurements

- Automatic and repetitive acquisition of time resolved images & maps
 - *close to real time visualization of samples during in-situ experiments*
- Applicable to EDS/EBSD/TKD on SEM and EDS on TEM
- Works on same location or multiple user defined locations



“Elevated temperature transmission Kikuchi diffraction in the SEM” Fanta et al, Materials Characterization, Vol. 139, May 2018, Pages 452-462

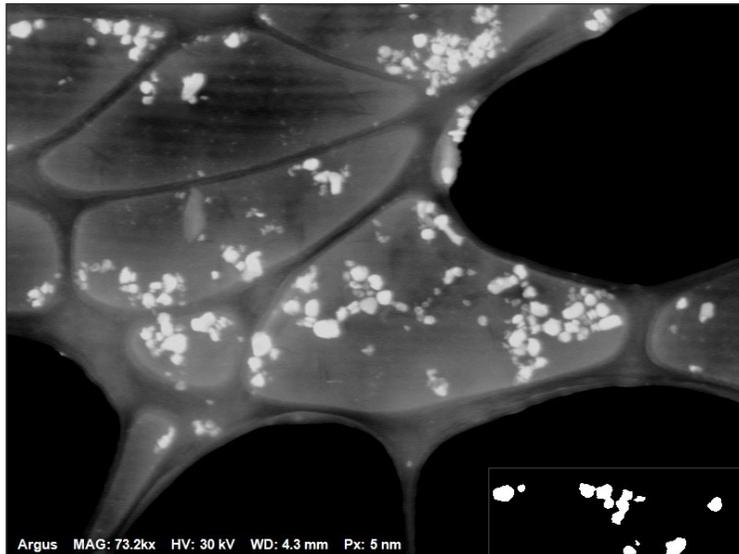
ESPRIT MaxYield

Productivity boost



ESPRIT MaxYield => key details / *benefits*:

- Acquire and binarize ARGUS/SEM images
- Use such images as masks to map sparse samples, e.g. nanoparticles, nanorods, nanotubes, etc.
- Acquire data only from the area of interest:
 - Productivity boost
 - Reduced drift induced artifacts



ARGUS image of nanoparticles on C-lacey support film



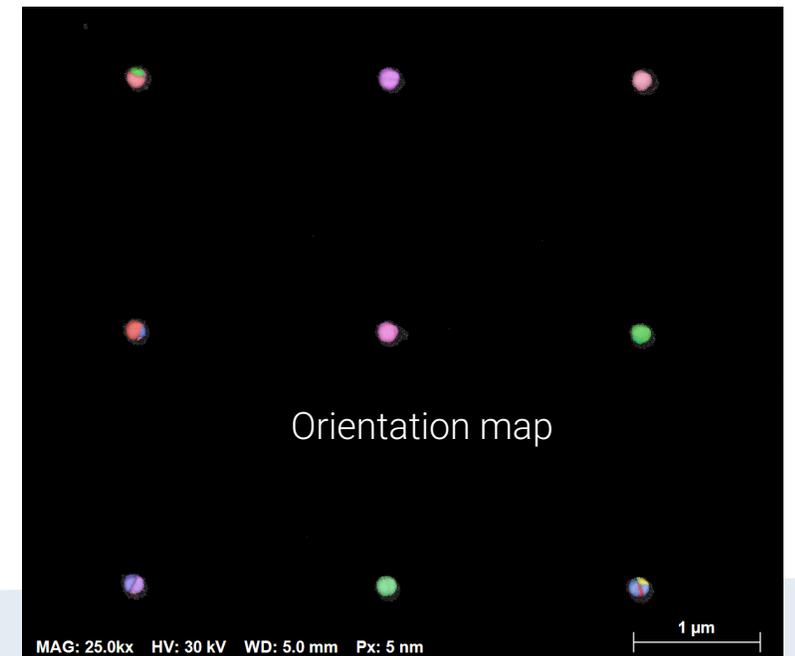
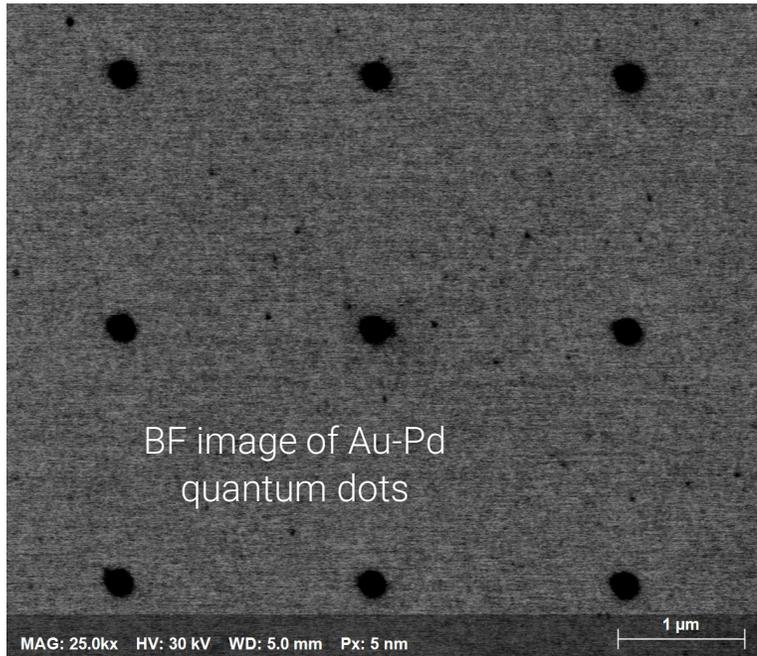
Binarized image to be used as a mask

ESPRIT MaxYield

Productivity boost



- Use masks to map sparse samples, e.g. nanoparticles, nanorods, nanotubes, etc.
- Acquire data only from the area of interest

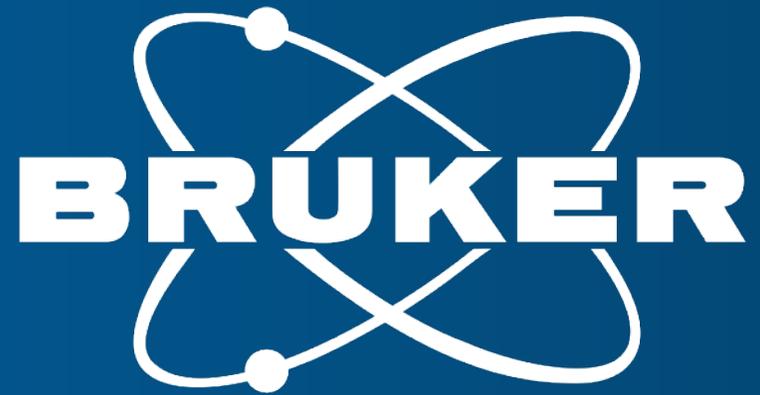




Thank you!

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Daniel.Goran@bruker.com



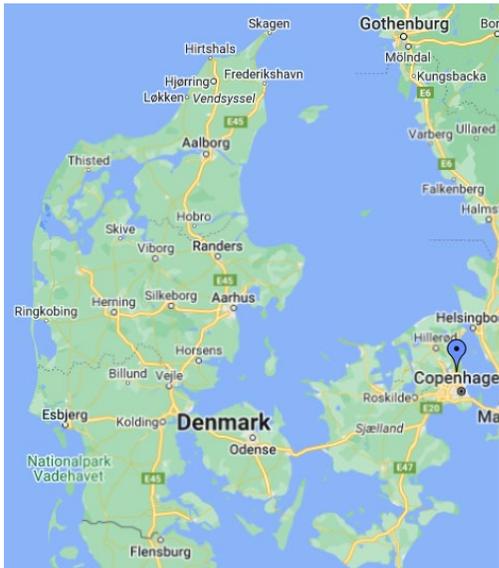
Innovation with Integrity

On-axis TKD at DTU Nanolab

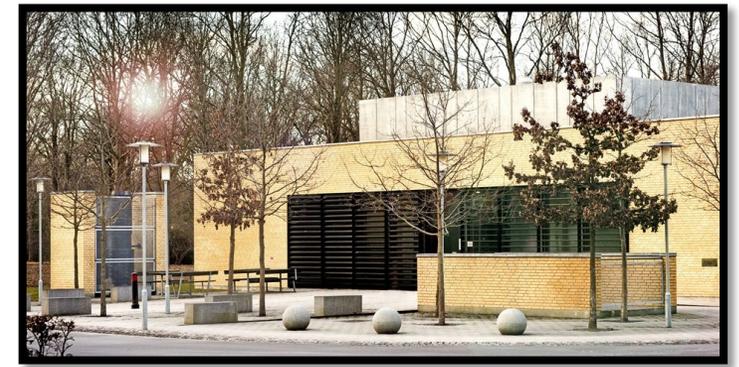
Alice Bastos da Silva Fanta

Technical University of Denmark (DTU)

Nanolab - National Centre for Nano Fabrication and Characterization



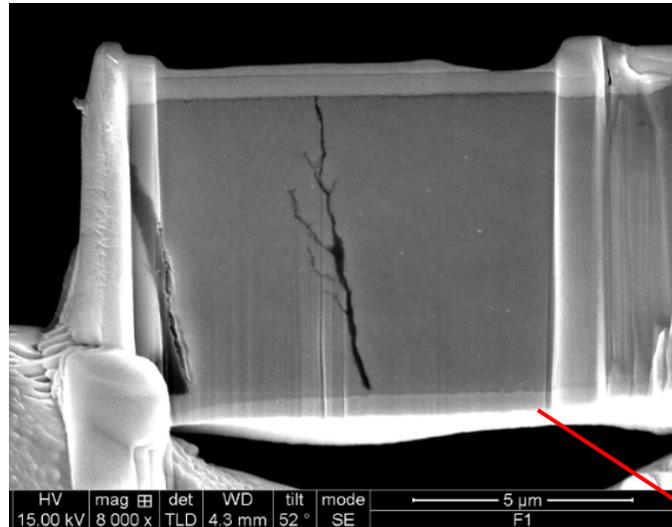
Clean room facility at DTU



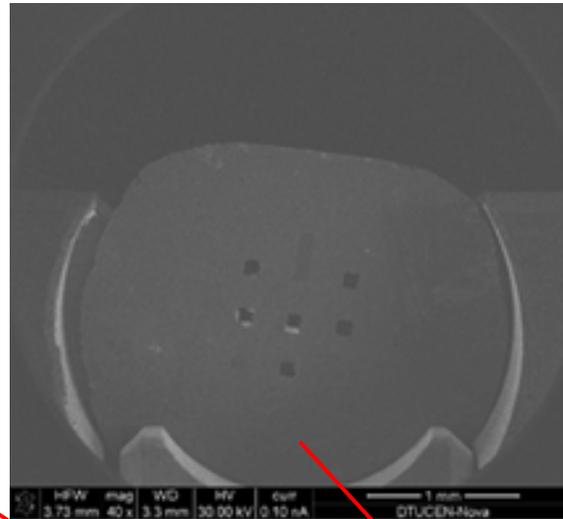
Electron microscopy facility at DTU

- General experience with setting up a TKD experiment
- Some examples of TKD applications
 - Characterization of nanoparticles
 - Thin film thermostability

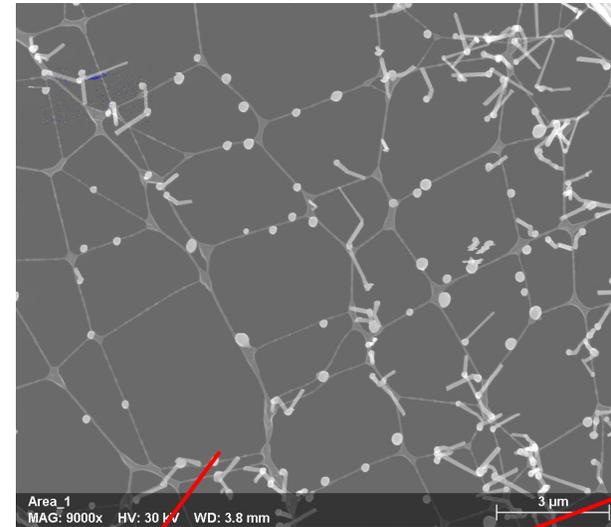
FIB lamella (steel)



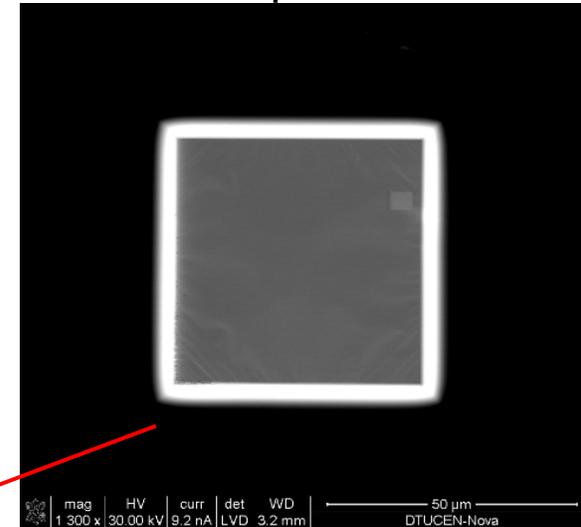
Thin films on TEM windows



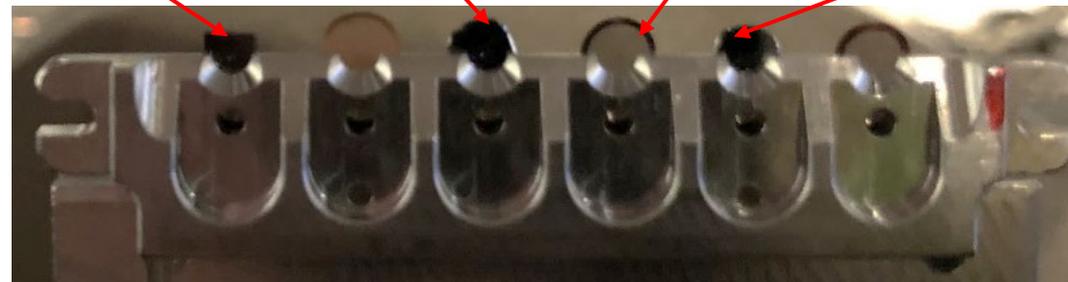
Lacey Carbon TEM grids with nanowires or nanoparticles



In-house designed TEM windows with arrays of nanoparticles



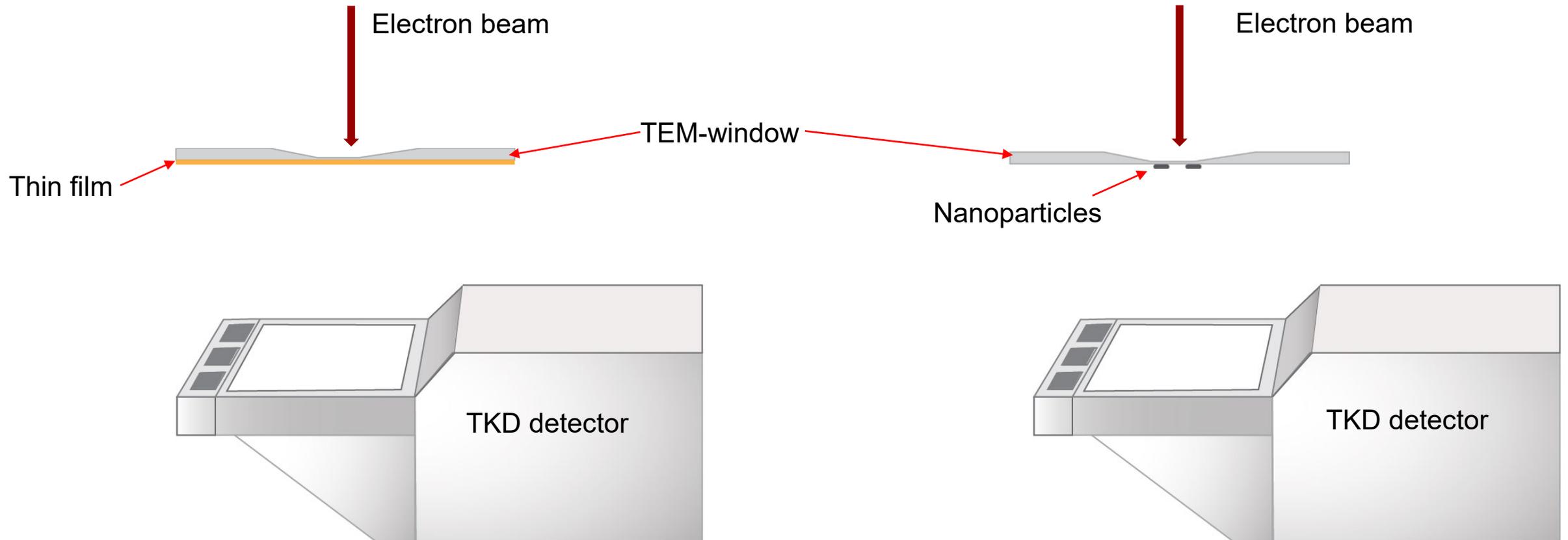
6 samples in one holder



DTU Setup - Samples

Because most of the signal arriving at the detector comes from the **last diffraction event**

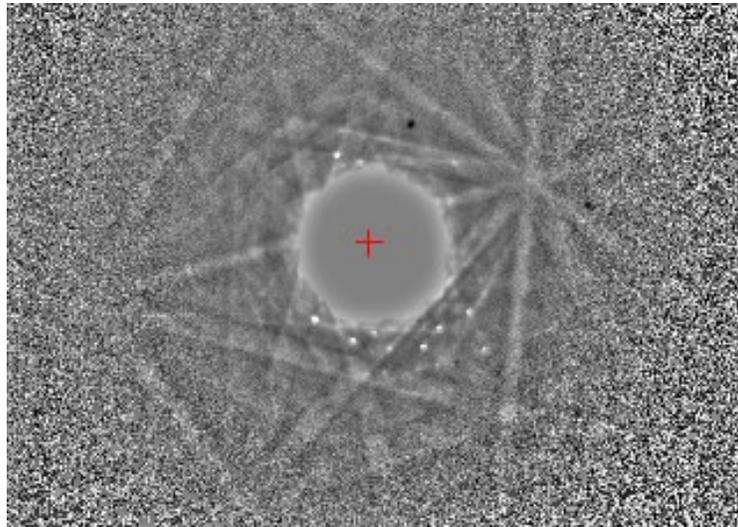
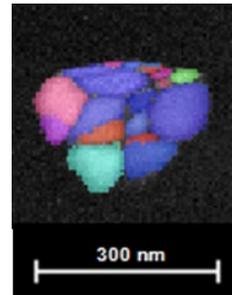
The samples are always **facing the detector, not the electro beam!**



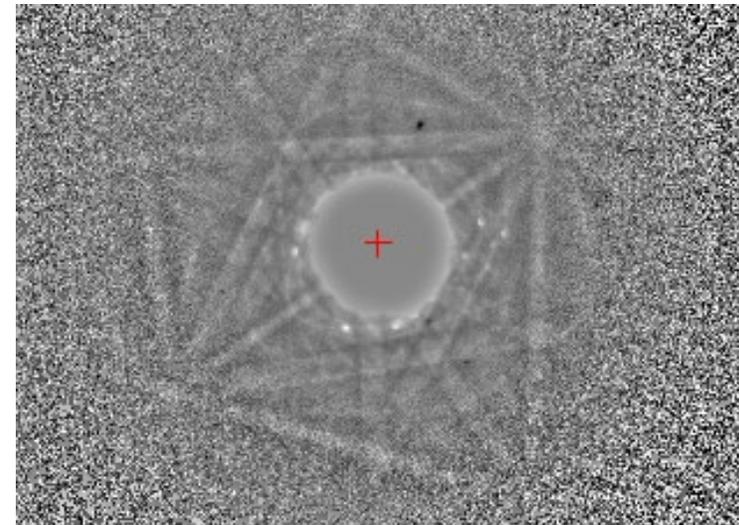
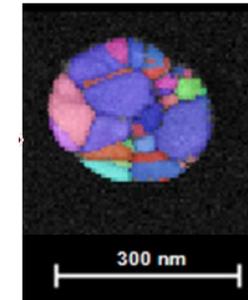
DTU Setup – Dealing with charging effects

- ➔ 1. Tip: Let everything stabilize before start mapping
- ➔ 2. Tip: Measure as fast as possible
- ➔ 3. Tip: If possible, measure in low vacuum condition (water vapor)

High vacuum

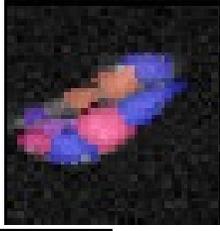


Low vacuum (50Pa)



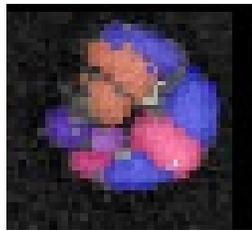
DTU Setup – Dealing with charging effects

High Vacuum



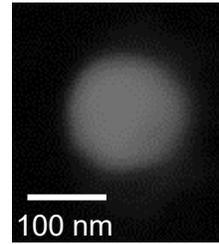
100nm

Low Vacuum

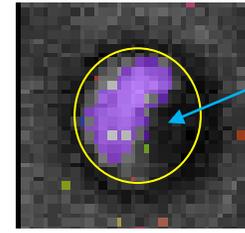


100nm

Cu-particles oxidizes faster in low vacuum



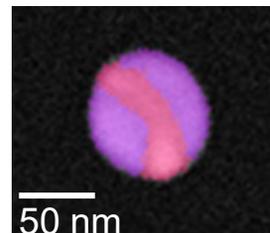
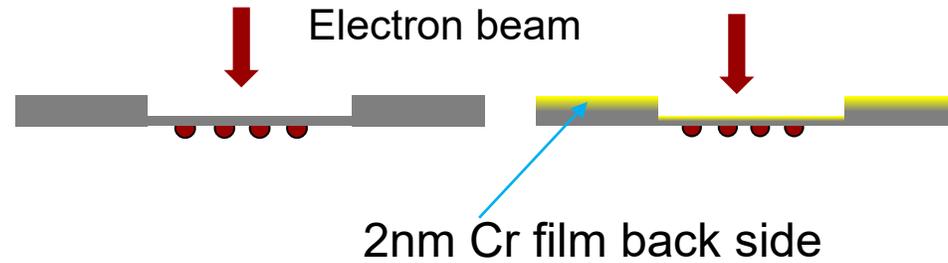
100 nm



oxidized

100 nm

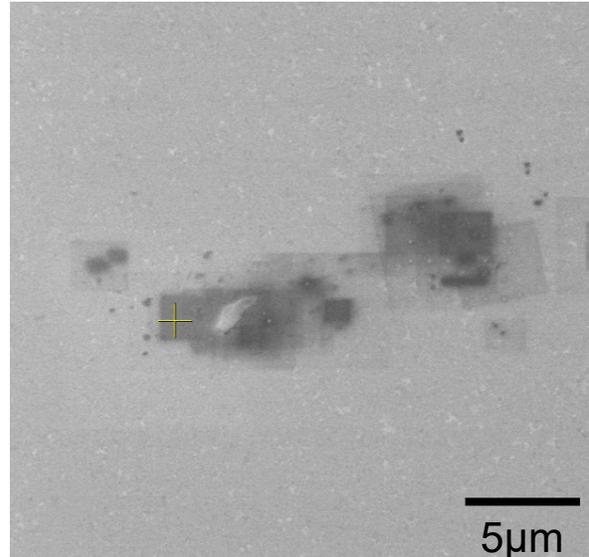
➔ 4. Tip: Coating



50 nm

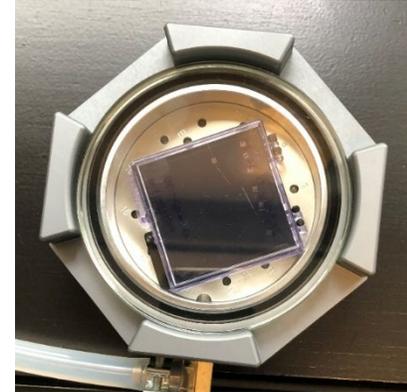


CARBON CONTAMINATION

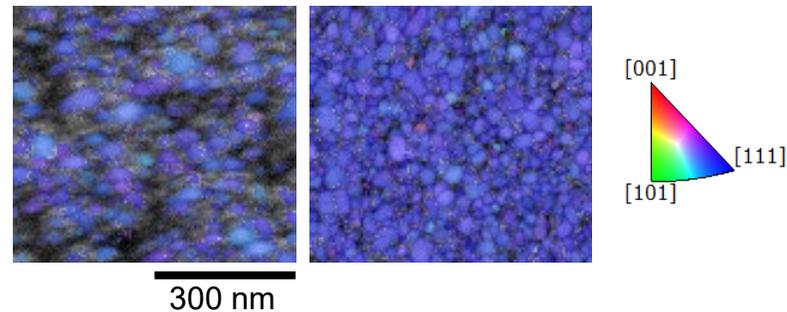


Always a challenge!

- We have introduced a Cryo-can and Cryo finder,
- We do our best to keep the sample and microscope clean.



- We always plasma clean the sample in the SEM chamber previous to any experiment.



Index-rate improves significantly

Ref. : A.B. Fanta et al. Mater. Charact. 139 (2018) 452–462.

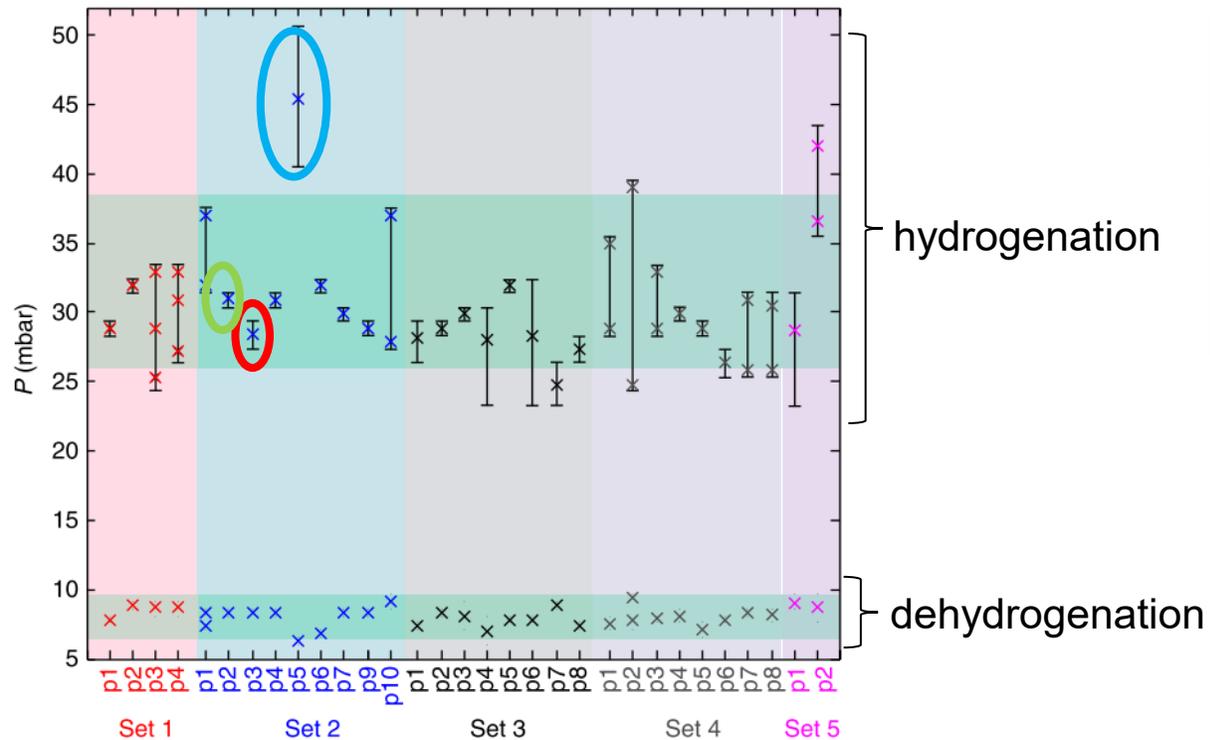
DTU Application: Optical hydrogen sensors

In collaboration with: Christoph Langhammer and Svetlana Alekseeva (Chalmers University of Technology)

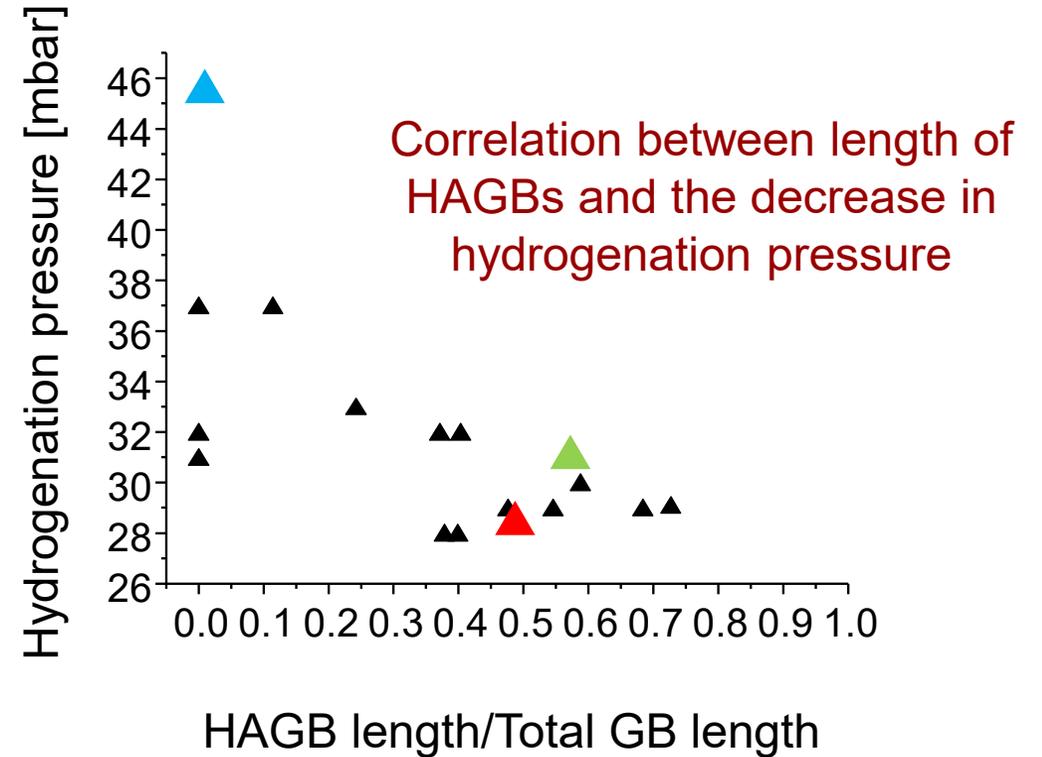
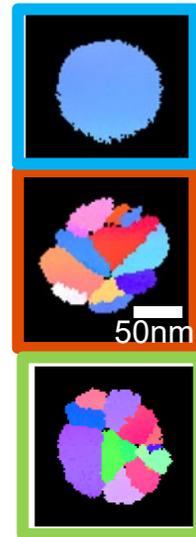
Particle-specific hydride formation

26 particles

(De) hydrogenation pressures of single Pd nanoparticles



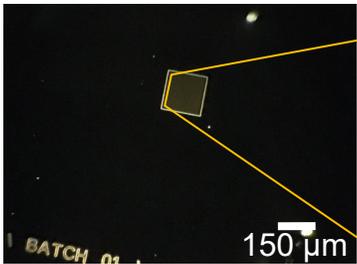
Study the role of the microstructure with TKD on hydrogenation of individual nanoparticle.



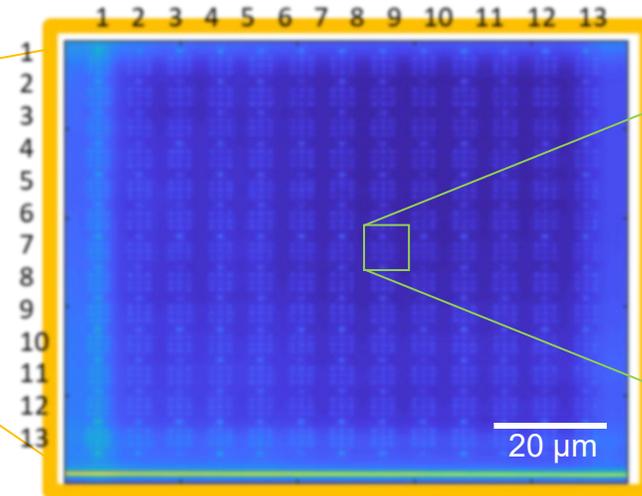
Ref. : S. Alekseeva et al., *Nat. Commun.* 8 (2017) and Nugroho et al., *Nat. Materials* (2019).

Extend it to 1000 particles

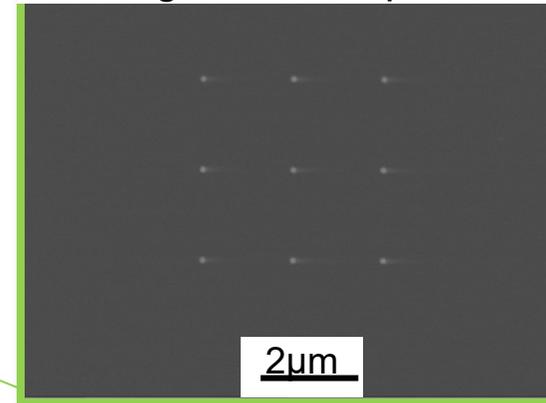
TEM Window



Particles arrangement on TEM window



SE-image: Set of 9 particles



Challenge: STEM and TKD

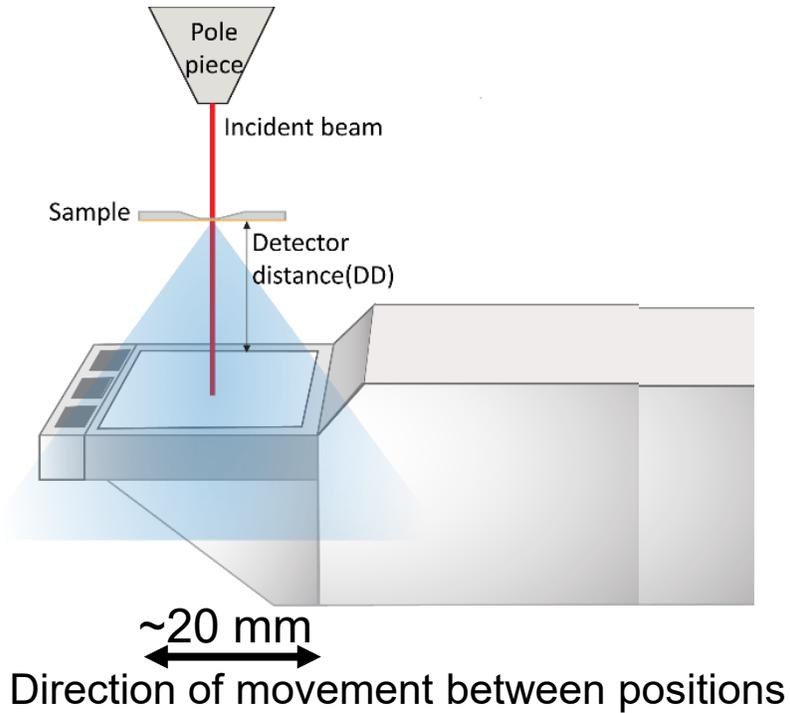
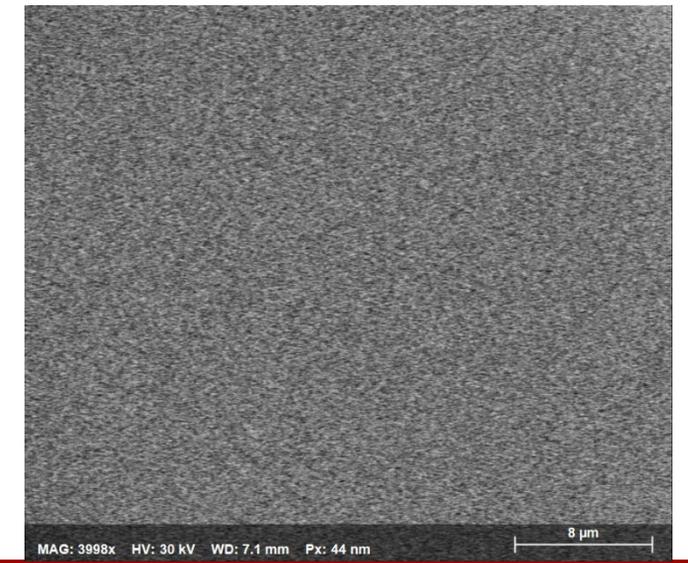
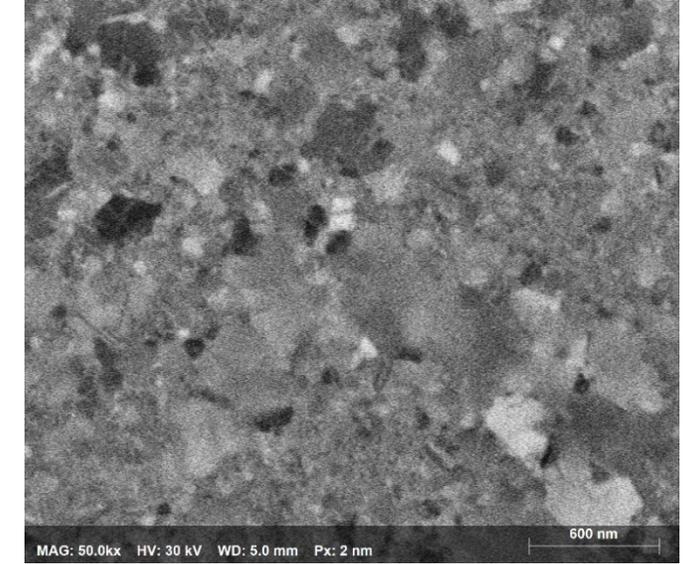
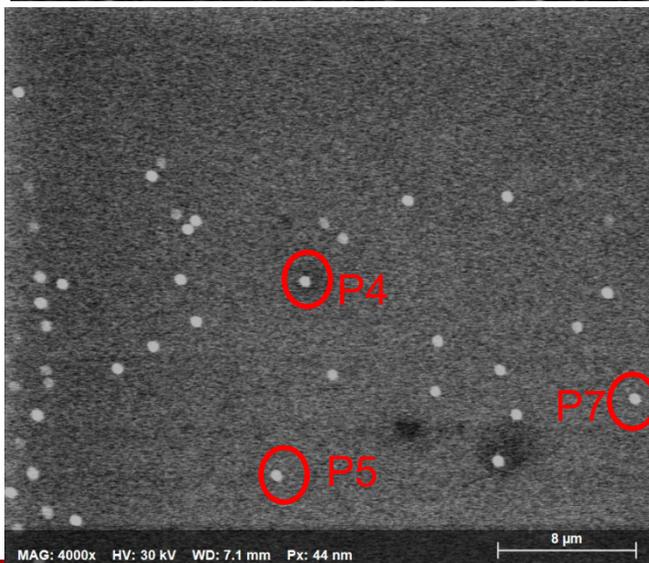
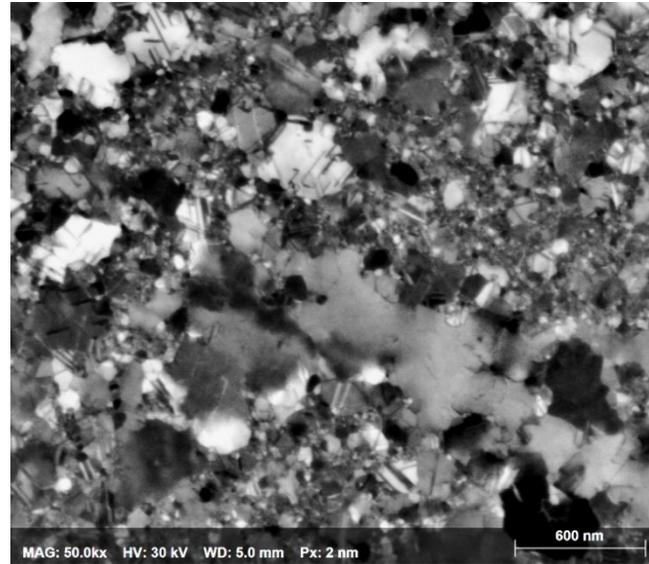


Image displacement of up to 1 μm

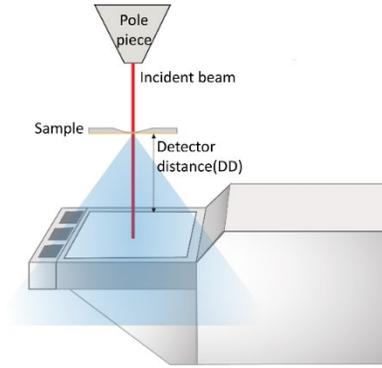
Poor image quality in measurement position

Imaging position ^{STEM image} Measuring position



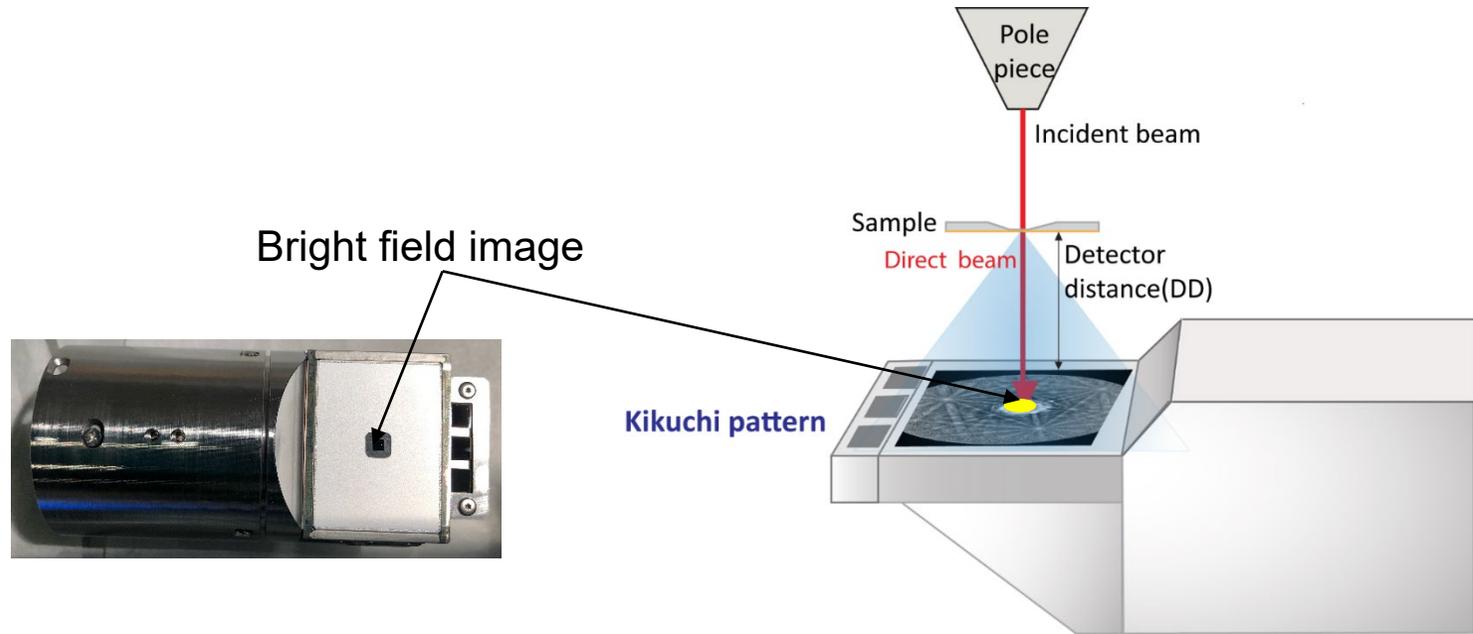
How to deal with this?

- Tilt the detector down
- Move the detector slowly following the image shift on the SE image
- Take advantage of the carbon contamination to re-locate the position (Sometime useful 😊)



STEM image and TKD measurement **without detector movement**

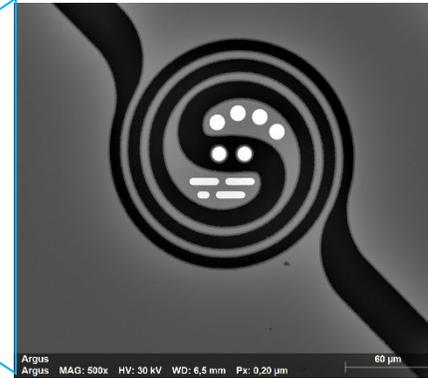
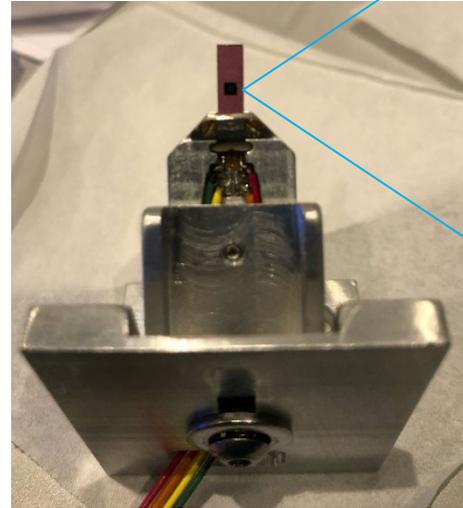
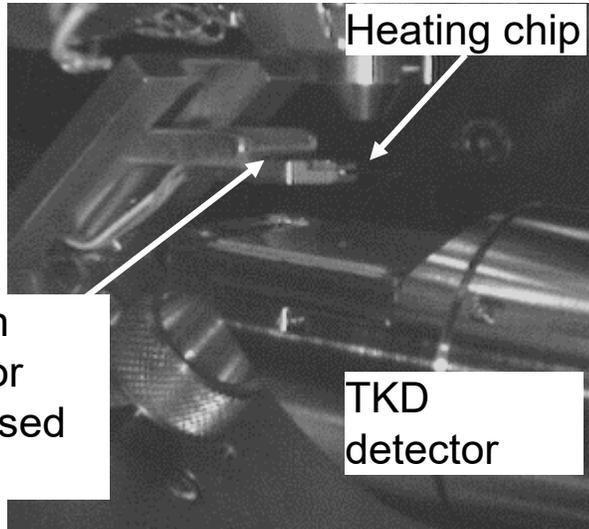
OPTIMUS 2



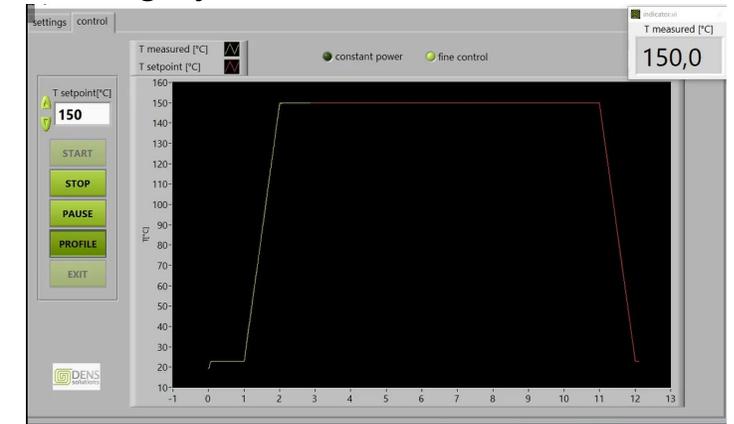
<https://www.bruker.com>

Ref.: Fanta, A. B. S., et al. (2019). *Ultramicroscopy* 206 112812. <https://doi.org/10.1016/J.ULTRAMIC.2019.112812>

Build an SEM stage for the TEM heating chip

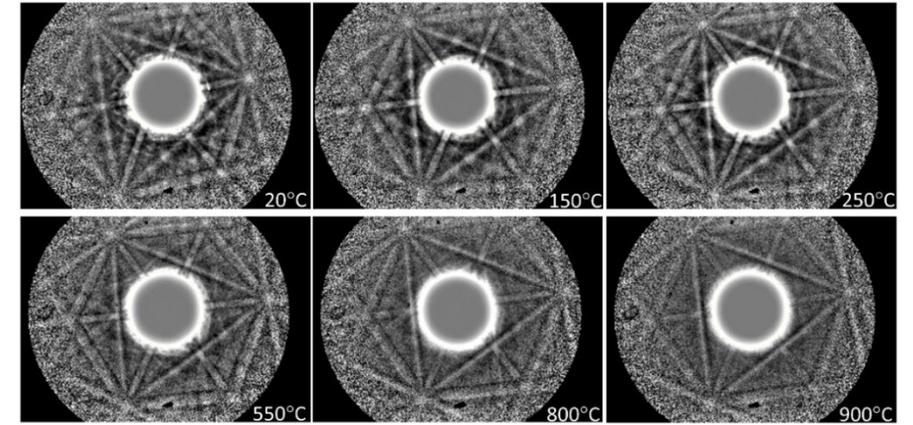
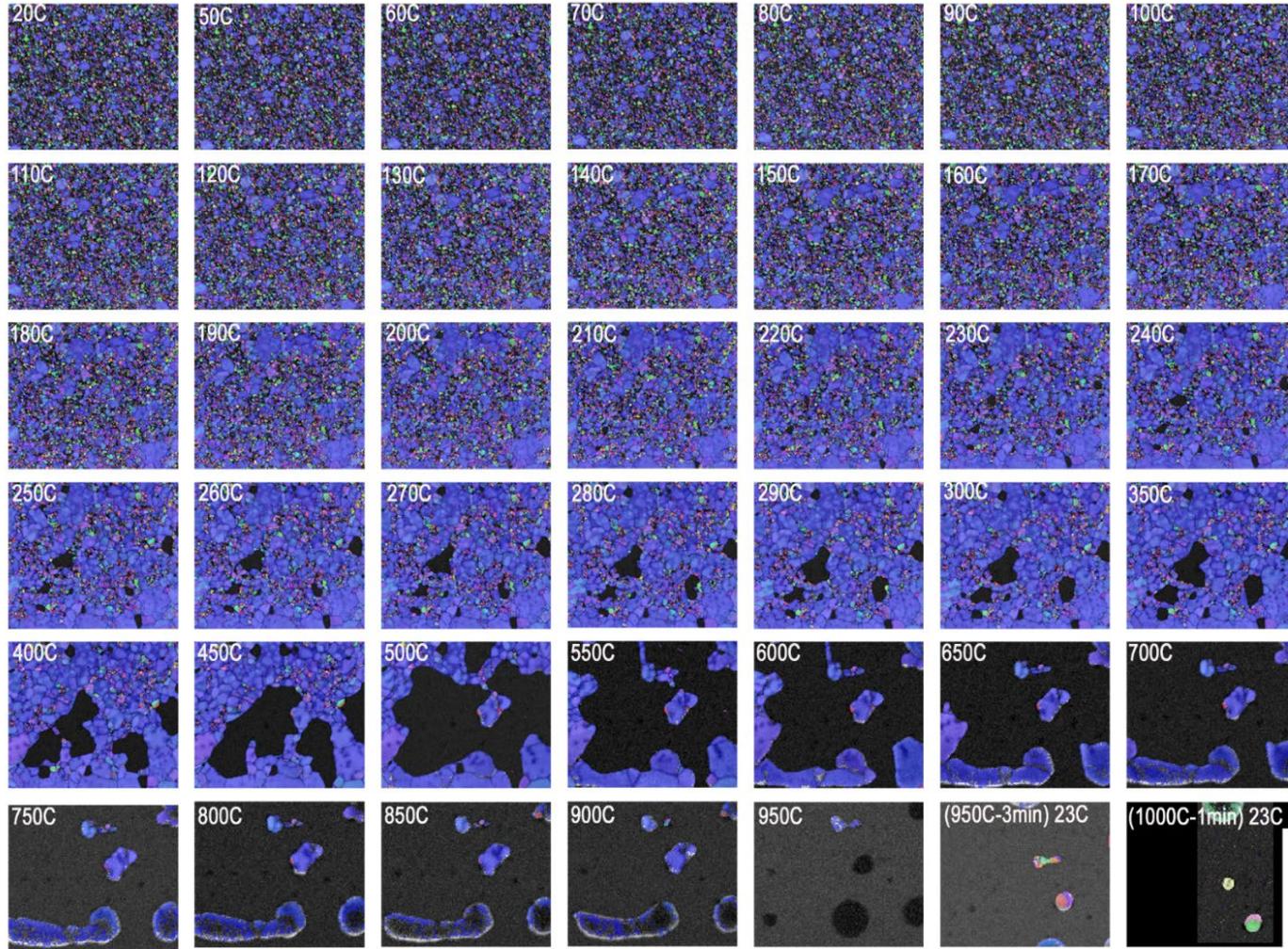


DENS Solution software to control heating cycle



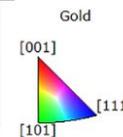
Ref. : A.B. Fanta et al. Mater. Charact. 139 (2018) 452–462.

In-situ dewetting of Au thin film



Map time 10min
 10 nm step size

Significant microstructure changes during the map



Ref. : A.B. Fanta et al. Mater. Charact. 139 (2018) 452–462.

DTU ThermoStability of thin films – Optimus 2

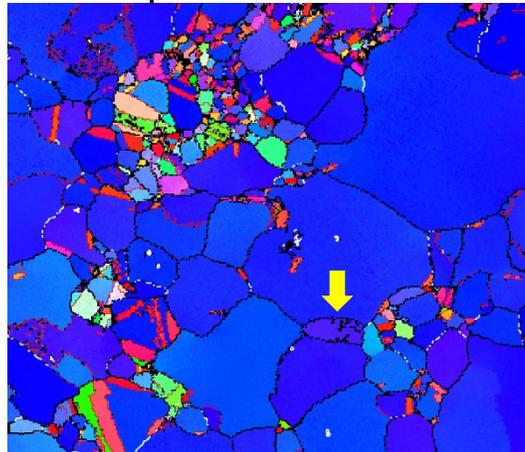


OPTIMUS 2



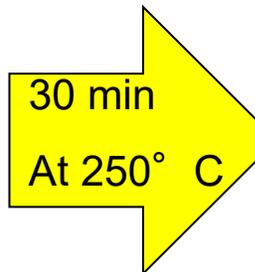
- Possibility to improve time and spatial resolution by automatically capture STEM images during heating experiments

TKD map after 30 min 200° C

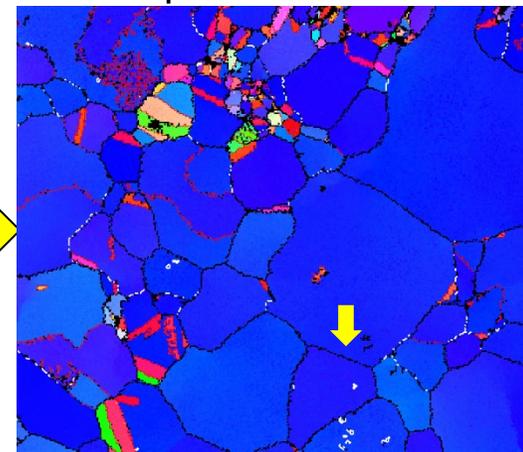


RT for 40 min

Map with 2 nm step size



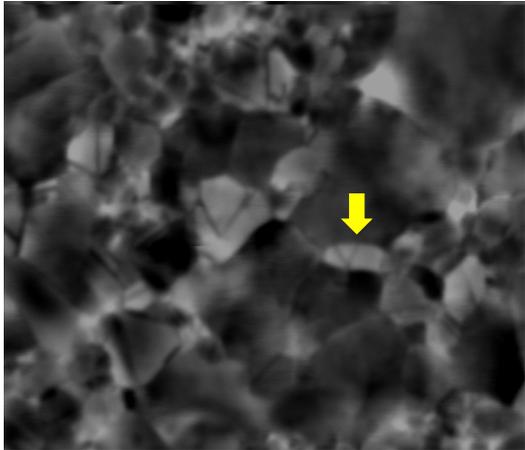
TKD map after 30 min 250° C



200 nm

Ref.: Fanta, A. B. S., et al. (2019). *Ultramicroscopy* 206 112812. <https://doi.org/10.1016/J.ULTRAMIC.2019.112812>

200° C

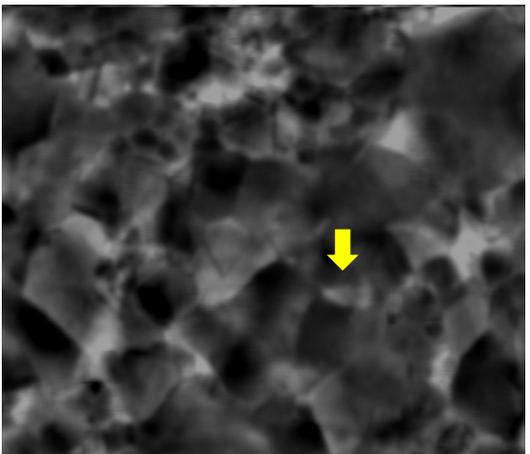


- 30 min STEM images (manually saved every 45 sec)
- 40 min map at RT

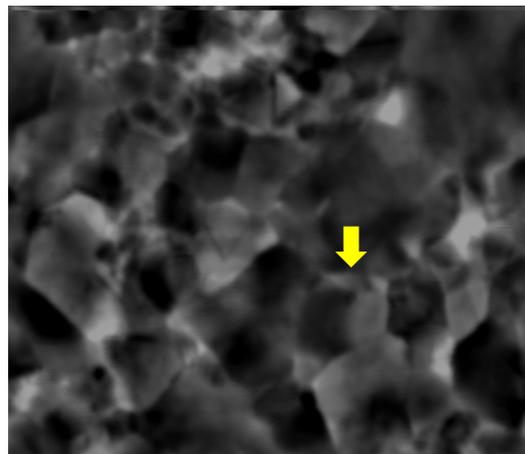


Prototype

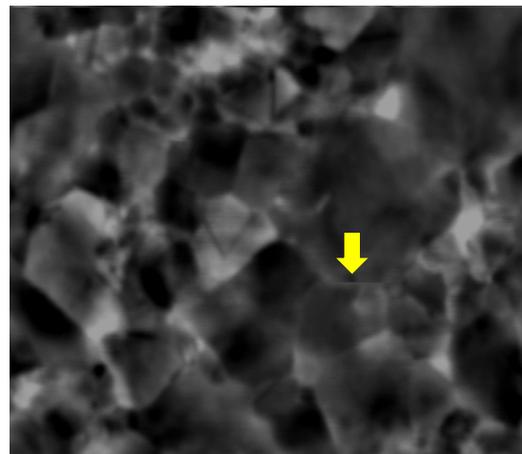
250° C



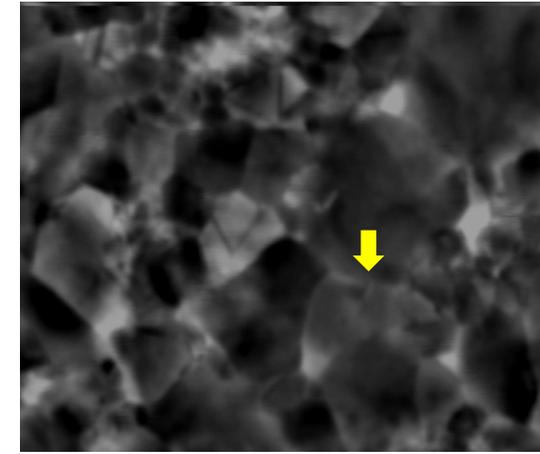
250° C (45s)



250° C (1.5 min)

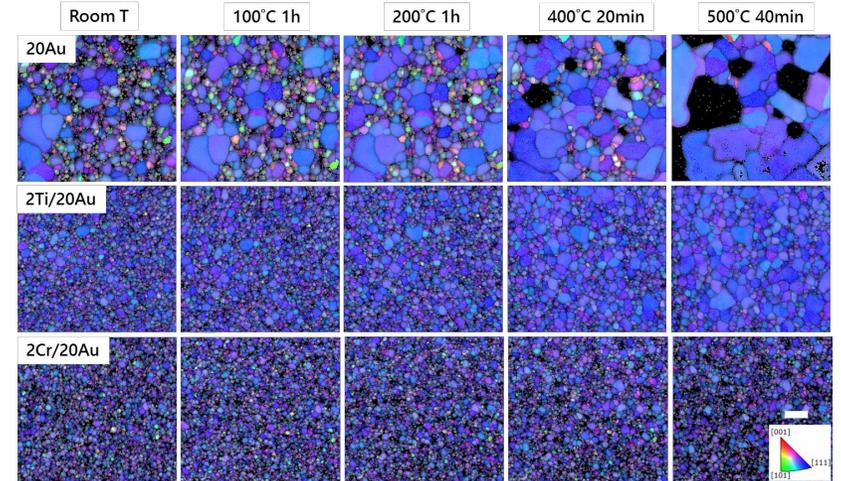


250° C (2.3 min)

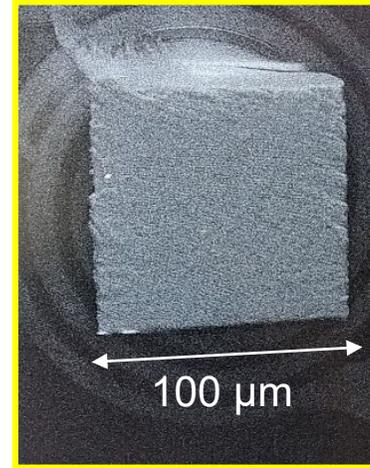
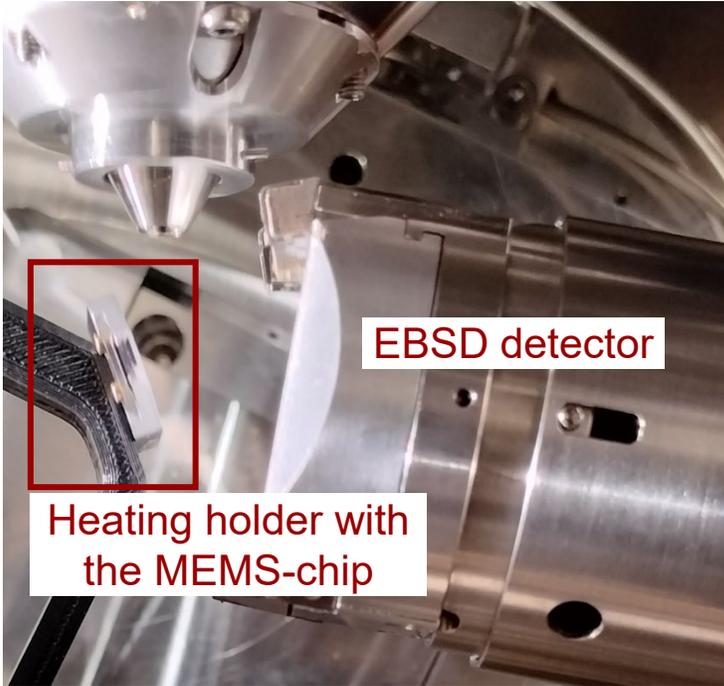


200 nm

Adhesion layer influence



Next-step: In-situ EBSD with MEMS based heating chips



Thanks to the people who contributed to the work:

DTU: Christian Damsgaard, Christina König

Former DTU: Adam Fuller, Matteo Todeschini, Mario Heinig, Andrew Burrows, Hossein Alimadadi, Mohammad Ahmed and Mamadou Mandie Kone

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Thank you for your attention

Screen recording during heating of Au thin films 40 x faster



200nm